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Substitute for form 1449A/PTO

**INFORMATION DISCLOSURE
STATEMENT BY APPLICANT**

(use as many sheets as necessary)

Sheet	1	of	3	Application Number	09/731,891
				Filing Date	12/6/00
				First Named Inventor	Steven Teig
				Group Art Unit	2825
				Examiner Name	Thuan Do
				Attorney Docket Number	SPLX.P0002

U.S. PATENTS RELATED TO THE PRESENT APPLICATIONS

Examiner's Initials	Cite No. ¹	U.S. Patent Document Number Kind Code ² (if known)	Name of Patentee or Applicant of Cited Document	Date of Publication MM-DD-YYYY	Relation to Present Application
TD	1.	6,516,455 B1	Teig, et al.	02-10-02	CIP of the present application

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TD	21.	6,068,662	Scepanovic et al.	05-30-00	

Examiner Signature	Thuan Do	Date Considered	6-4-03
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		Office ²	Number ¹	Kind Code (if known) ³				
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NON PATENT LITERATURE DOCUMENTS

Examiner* Initials	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.						T ⁶

Examiner Signature	<i>Urando</i>	Date Considered	6/4/03
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				Attorney Docket Number	SPLX.P0002

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Examiner Signature	<i>Muhammad</i>	Date Considered	6/4/03
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